AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claim 1 (currently amended): A cooler with a circulating cooling liquid for an electronic device which cools a heating element provided on the electronic device by circulating a cooling liquid, which comprises comprising:

a substrate;

a liquid cooling mechanism, composed of:

a heat sink formed in a flat shape with a liquid channel to have a heat-receiving face at a surface thereof intended to be made in contact with said heating element, and having a liquid channel formed therein,

a pump portion having an impeller rotatably provided in a <u>flat-shape to circulate said</u> cooling liquid housing formed in a flat shape within said substrate to circulate said cooling liquid,

metal pipes for circulating said cooling liquid therethrough;

a forcible air cooling mechanism, composed of:

a radiating fin provided on the outer surface surfaces of said metal pipes and

a fan to cool said radiating fin and said housing,

wherein said pump portion of the liquid cooling mechanism and said fan of the forcible air cooling mechanism being provided on the substrate in a vertically aligned positional relationship such that said liquid cooling mechanism and said forcible air cooling mechanism are unified.

Claim 2 (original): The cooler for an electronic device as claimed in Claim 1, wherein said impeller and said fan are arranged in such a manner that the axis of the rotation of the impeller forming said liquid cooling mechanism and the axis of the rotation of the fan forming said forcible air cooling mechanism are positioned on an identical line.

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Claim 3 (original): The cooler for an electronic device as claimed in Claim 1 or 2, wherein said fan and said impeller are rotated together.

Claim 4 (original): The cooler for an electronic device as claimed in Claim 3, wherein a magnet for rotating the fan which rotates under the influence of the magnetic fluctuation of the motor substrate and a magnet for driving the impeller are placed on said fan while a passive magnet which receives the magnetic force from said magnet for driving the impeller, is placed on said impeller.

Claim 5 (original): The cooler for an electronic device as claimed in Claim 3, wherein a magnet for rotating the fan which rotates under the influence of the magnetic fluctuation of the motor substrate is placed on said fan while a passive magnet which receives the magnetic force of said magnet for rotating the fan is placed on said impeller such that said fan and said impeller are rotated together.

Claim 6 (previously presented): The cooler for an electronic device as claimed in Claim 4, wherein said motor substrate is made of an insulating plate having a coil formed on the surface thereof, said fan is in the form of a thin plate having a plurality of bent blades on the periphery of a thin plate having a rotation axis at the middle portion thereof, and said motor substrate, said fan and said pump portion in a flat form are laminated on each other.

Claim 7 (original): The cooler for an electronic device as claimed in Claim 1, wherein the metal pipes each connecting the pump portion to the liquid channel of the heat sink are folded at least once between the pump portion and the heat sink, and said radiating fin is placed between the folded metal pipes.

Claim 8 (original): The cooler for an electronic device as claimed in Claim 7, wherein said radiating fin and the portions of said metal pipes on which the radiating fin is placed are mounted

on and in contact with a mounting plate having the housing provided thereon to form the pump portion.

Claim 9 (original): The cooler for an electronic device as claimed in Claim 8, wherein a port capable of having air being passed therethrough is formed on at least one portion of the mounting plate where the radiating fin is positioned.

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Claim 10 (original): The cooler for an electronic device as claimed in Claim 1, wherein the heat sink is made of aluminum which is a highly heat-conductive material, and that the metal pipe is made of copper.

Claim 11 (previously presented): The cooler for an electronic device as claimed in Claim 5, wherein said motor substrate is made of an insulating plate having a coil formed on the surface thereof, said fan is in the form of a thin plate having a plurality of bent blades on the periphery of a thin plate having a rotation axis at the middle portion thereof, and said motor substrate, said fan and said pump portion in a flat form are laminated on each other.